

SRM20V100LLMT₇/SLMT₇



1M-Bit Static RAM

- Low Supply Voltage
- Wide Temperature Range
- Low Supply Current
- Access Time 70ns (2.7V)
- 131,072 Words×8-Bit Asynchronous

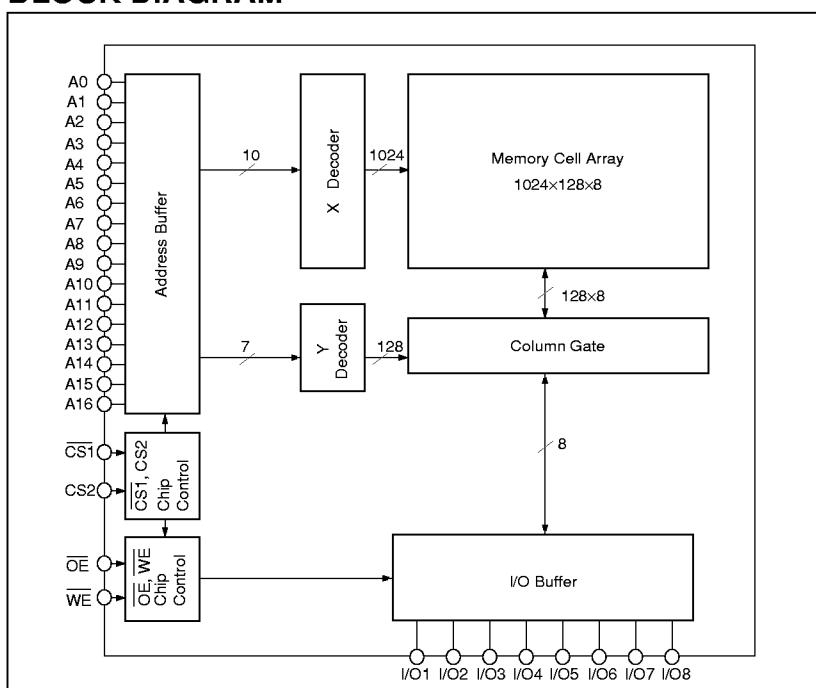
■ DESCRIPTION

The SRM20V100LLMT₇/SLMT₇ is an 131,072 words×8-bit asynchronous, static, random access memory on a monolithic CMOS chip. Its very low standby power requirement makes it ideal for applications requiring non-volatile storage with back-up batteries. And -40 to 85°C operating temperature range makes it ideal for portable equipment. The asynchronous and static nature of the memory requires no external clock or refreshing circuit. Both the input and output ports are TTL compatible and 3-state output allows easy expansion of memory capacity.

■ FEATURES

- Wide temperature range -40 to 85°C
- Fast Access time 70ns (Max.)
- Low supply current Standby: 0.6μA (Typ.): LL Version
0.5μA (Typ.): SL Version
Operation: 8mA/1MHz (Typ.)
- Completely static No clock required
- Supply voltage 2.7V to 3.6V
- TTL compatible inputs and outputs
- 3-state output with wired-OR capability
- Non-volatile storage with back-up batteries
- Package SRM20V100LLMT₇ SOP6-32pin (plastic)
SRM20V100SLMT₇ SOP6-32pin (plastic)
SRM20V100LLTT₇ TSOP (I)-32pin (plastic)
SRM20V100SLTT₇ TSOP (I)-32pin (plastic)
SRM20V100LLRT₇ TSOP (I)-32pin-R1 (plastic)
SRM20V100SLRT₇ TSOP (I)-32pin-R1 (plastic)
SRM20V100LLKT₇ Slim-TSOP (I)-32pin (plastic)
SRM20V100SLKT₇ Slim-TSOP (I)-32pin (plastic)
SRM20V100LLYT₇ Slim-TSOP (I)-32pin-R1 (plastic)
SRM20V100SLYT₇ Slim-TSOP (I)-32pin-R1 (plastic)

■ BLOCK DIAGRAM



■ PIN CONFIGURATION

(SOP6)	
N.C.	1
A16	2
A14	3
A12	4
A7	5
A6	6
A5	7
A4	8
A3	9
A2	10
A1	11
A0	12
I/O1	13
I/O2	14
I/O3	15
V _{SS}	16
	32
	31
	30
	29
	28
	27
	26
	25
	24
	23
	22
	21
	20
	19
	18
	17
	16
	V _{DD}
	A15
	CS2
	WE
	A13
	A8
	A7
	A6
	A5
	A4
	A3
	A2
	A1
	CS1
	I/O8
	I/O7
	I/O6
	I/O5
	I/O4
	I/O3
	I/O2
	I/O1
	A0
	A1
	A2
	A3
	OE
	SRM20V100LLMT ₇
	SRM20V100SLMT ₇

(TSOP/Slim-TSOP)	
A11	1
A9	2
A8	3
A7	4
A13	5
WE	6
CS2	7
A15	8
V _{DD}	9
N.C.	10
A16	11
A14	12
A12	13
A7	14
A6	15
A5	16
A4	17
	32
	31
	30
	29
	28
	27
	26
	25
	24
	23
	22
	21
	20
	19
	18
	17
	16
	OE
	A10
	CS1
	I/O8
	I/O7
	I/O6
	I/O5
	I/O4
	I/O3
	I/O2
	I/O1
	A0
	A1
	A2
	A3
	V _{SS}
	SRM20V100LLTT ₇
	SRM20V100SLTT ₇

(TSOP-R1/Slim-TSOP-R1)	
A4	16
A5	15
A6	14
A7	13
A12	12
A14	11
A16	10
N.C.	9
V _{DD}	8
A15	7
CS2	6
WE	5
A13	4
A8	3
A9	2
A11	1
	17
	18
	19
	20
	21
	22
	23
	24
	25
	26
	27
	28
	29
	30
	31
	32
	OE
	A3
	A2
	A1
	A0
	I/O1
	I/O2
	I/O3
	I/O4
	I/O5
	I/O6
	I/O7
	I/O8
	CS1
	A10
	SRM20V100LLRT ₇
	SRM20V100SLRT ₇

■ PIN DESCRIPTION

A0 to A16	Address Input
WE	Write Enable
OE	Output Enable
CS1, CS2	Chip Select
I/O1 to I/O8	Data I/O
V _{DD}	Power Supply (2.7V to 3.6V)
V _{SS}	Power Supply (0V)
N. C.	No connection

■ ABSOLUTE MAXIMUM RATINGS(V_{SS} = 0V)

Parameter	Symbol	Ratings	Unit
Supply voltage	V _{DD}	-0.5 to 4.6	V
Input voltage	V _I	-0.5 to V _{DD} +0.3	V
Input/Output voltage	V _{I/O}	-0.5 to V _{DD} +0.3	V
Power dissipation	P _D	0.5	W
Operating temperature	T _{opr}	-40 to 85	°C
Storage temperature	T _{stg}	-65 to 150	°C
Soldering temperature and time	T _{sol}	260°C, 10s (at lead)	—

*V_I, V_{I/O} (Min.) = -3.0V (Pulse width is 50ns)**■ DC RECOMMENDED OPERATING CONDITIONS**(V_{SS}=0V, Ta = -40 to 85°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage	V _{DD}	—	2.7	3.0	3.6	V
	V _{SS}	—	0	0	0	V
Input voltage	V _{IH}	—	2.2	—	V _{DD} +0.3	V
	V _{IL}	—	-0.3*	—	0.4	V

*If pulse width is less than 50ns, it is -3.0V

■ ELECTRICAL CHARACTERISTICS**● DC Electrical Characteristics**(V_{DD} = 2.7 to 3.6V, V_{SS} = 0V, Ta = -40 to 85 °C)

Parameter	Symbol	Conditions	Min.	Typ.*	Max.	Unit
Input leakage	I _{LI}	V _I =0 to V _{DD}	-1	—	1	μA
Output leakage	I _{LO}	CS1 = V _{IH} or CS2 = V _{IL} or WE = V _{IL} or OE = V _{IH} , V _{I/O} = 0 to V _{DD}	-1	—	1	μA
Standby supply current	I _{DDS}	CS1 = V _{IH} or CS2 = V _{IL}	—	—	1.0	mA
	I _{DDS1}	CS1=CS2≥V _{DD} -0.2V or CS2≤0.2V	LL -40 to 85 °C -40 to 70 °C -40 to 40 °C	—	—	60
				—	—	18
				—	—	6.0
			25 °C	—	0.6	2.0
			SL -40 to 85 °C -40 to 70 °C -40 to 40 °C	—	—	30
				—	—	12
				—	—	2.0
				—	0.3	1.0
Average operating current	I _{DDA}	V _I = V _{IL} , V _{IH} I _{I/O} = 0mA, t _{cyc} = Min.	—	20	35	mA
	I _{DDA1}	V _I = V _{IL} , V _{IH} I _{I/O} = 0mA, t _{cyc} = 1μs	—	3	5	mA
Operating supply current	I _{DDO}	V _I = V _{IL} , V _{IH} I _{I/O} = 0mA	—	3	5	mA
High level output voltage	V _{OH}	V _{DD} ≥3V, I _{OH} = -2.0mA	2.4	—	—	V
		I _{OH} = -100μA	V _{DD} -0.2	—	—	
Low level output voltage	V _{OL}	V _{DD} ≥3V, I _{OL} = -2.0mA	—	—	0.4	V
		I _{OL} = 100μA	—	—	0.2	

*Typical values are measured at Ta=25°C and V_{DD}=3.0V**● Terminal Capacitance**

(f = 1MHz, Ta = 25 °C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Address Capacitance	C _{ADD}	V _{ADD} =0V	—	—	8	pF
Input Capacitance	C _I	V _I =0V	—	—	8	pF
I/O Capacitance	C _{I/O}	V _{I/O} =0V	—	—	10	pF

Note) This parameter is made by the inspection data of a sample, not of all products.

● AC Electrical Characteristics

○ Read Cycle

(V_{DD} = 2.7V to 3.6V, V_{SS} = 0V, Ta = -40 to 85°C)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Read cycle time	t _{RC}	*1	70	—	ns
Address access time	t _{ACC}		—	70	ns
Chip select1 access time	t _{ACS1}		—	70	ns
Chip select2 access time	t _{ACS2}		—	70	ns
Output enable access time	t _{OE}		—	40	ns
Chip select1 output set time	t _{CLZ1}	*2	5	—	ns
Chip select1 output floating	t _{CHZ1}		—	30	ns
Chip select2 output set time	t _{CLZ2}		5	—	ns
Chip select2 output floating	t _{CHZ2}		—	30	ns
Output enable output set time	t _{OLZ}		0	—	ns
Output enable output floating	t _{OHZ}		—	30	ns
Output hold time	t _{OH}	*1	10	—	ns

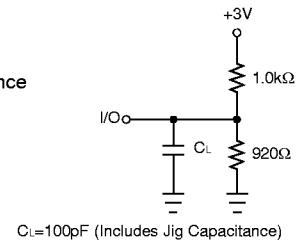
○ Write Cycle

(V_{DD} = 2.7V to 3.6V, V_{SS} = 0V, Ta = -40 to 85°C)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Write cycle time	t _{WC}	*1	70	—	ns
Chip select time1	t _{CW1}		60	—	ns
Chip select time2	t _{CW2}		60	—	ns
Address enable time	t _{AW}		60	—	ns
Address setup time	t _{AS}		0	—	ns
Write pulse width	t _{WP}		55	—	ns
Address hold time	t _{WR}		0	—	ns
Input data setup time	t _{DW}		30	—	ns
Input data hold time	t _{DH}		0	—	ns
WE Output floating	t _{WHZ}		—	30	ns
WE Output setup time	t _{OW}	*2	5	—	ns

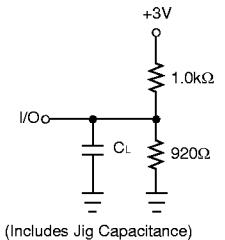
*1 Test Conditions

1. Input pulse level: 0.4V to 2.4V
2. t_r = t_f = 5ns
3. Input and output timing reference levels :1.5V
4. Output load C_L = 100pF

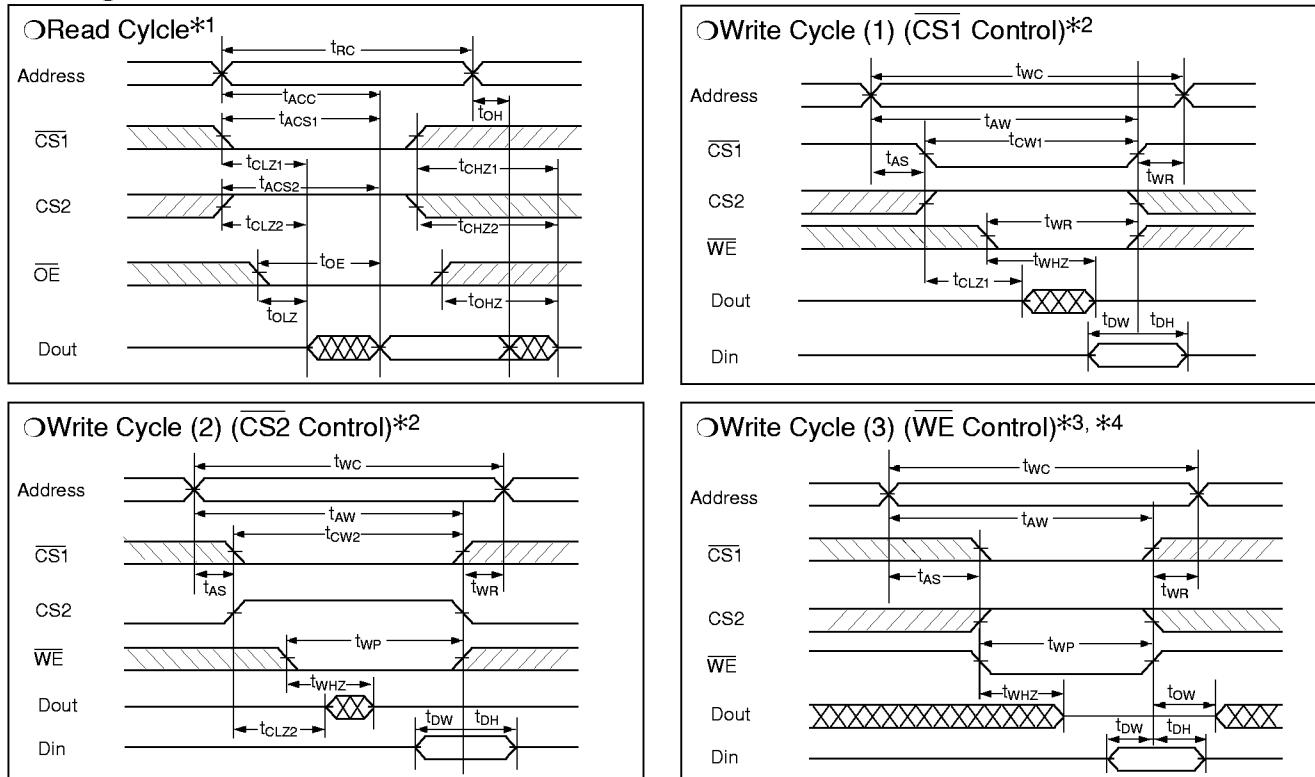


*2 Test Conditions

1. Input pulse level : 0.4V to 2.4V
2. t_r = t_f = 5ns
3. Input timing reference levels: 1.5V
4. Output timing reference levels: ±200mV (the level displaced from stable output voltage level)
5. Output load C_L = 5pF



● Timing chart



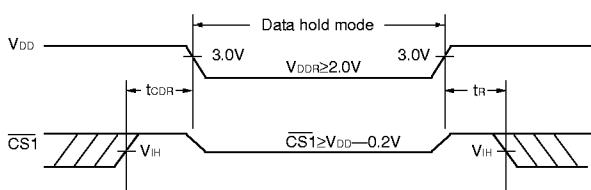
- Note :
1. During read cycle time, WE is to be "H" level.
 2. During write cycle time that is controlled by CS1 or CS2, Output Buffer is in high impedance state, whether OE level is "H" or "L".
 3. During write cycle time that is controlled by WE, Output Buffer is high impedance state if OE is "H" level.
 4. When I/O terminals are output mode, be careful that do not give the opposite signals to the I/O terminals.

● DATA RETENTION CHARACTERISTIC WITH LOW VOLTAGE POWER SUPPLY

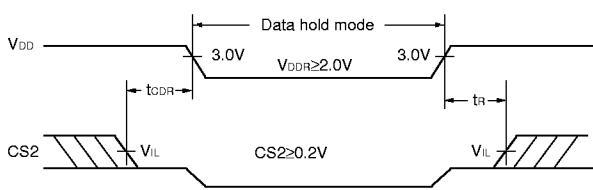
($V_{SS} = 0V$, $T_a = -40$ to $85^{\circ}C$)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Data retention Supply voltage	V_{DDR}			2.0	—	3.6	V
Data retention current	I_{DDR}	$V_{DD} = 3.0V$ $CS1 = CS2 \geq V_{DD} - 0.2V$ or $CS2 \leq 0.2V$	LL	—	—	50	μA
			—40 to 85 °C	—	—	25	
			—40 to 70 °C	—	—	12	
			25 °C	—	0.6	1.0	
		SL	—40 to 85 °C	—	—	25	
			—40 to 70 °C	—	—	10	
			—40 to 40 °C	—	—	1.0	
			25 °C	—	0.3	0.5	
Chip select data hold time	t_{CDR}			0	—	—	ns
Operation recovery time	t_R			5	—	—	ms

Data retention timing (CS1 Control)



Data retention timing (CS2 Control)



* when retaining data in standby mode, supply voltage can be lowered with in a certain range. But read or write cycle cannot be performed while the supply voltage is low.

■ FUNCTIONS

● Truth Table

$\overline{\text{CS1}}$	CS2	$\overline{\text{OE}}$	$\overline{\text{WE}}$	DATA I/O	Mode	I_{DD}
H	X	X	X	Hi-Z	Unselected	I_{DDS}, I_{DDS1}
X	L	X	X	Hi-Z	Unselected	I_{DDS}, I_{DDS1}
L	H	X	L	Input data	Write	I_{DDA}, I_{DDA1}
L	H	L	H	Output data	Read	I_{DDA}, I_{DDA1}
L	H	H	H	Hi-Z	Output disable	I_{DDA}, I_{DDA1}

X : "H" or "L"

● Reading data

Data is able to be read when the address is set while holding $\overline{\text{CS1}} = \text{"L"}$, $\text{CS2} = \text{"H"}$, $\overline{\text{OE}} = \text{"L"}$ and $\overline{\text{WE}} = \text{"H"}$. Since DATA I/O terminals are in high impedance state when $\overline{\text{OE}} = \text{"H"}$, the data bus line can be used for any other objective, then access time apparently is able to be cut down.

● Writing data

There are the following four ways of writing data into the memory.

- (1) Hold $\text{CS2} = \text{"H"}$, $\overline{\text{WE}} = \text{"L"}$, set addresses and give "L" pulse to $\overline{\text{CS1}}$.
- (2) Hold $\overline{\text{CS1}} = \text{"L"}$, $\overline{\text{WE}} = \text{"L"}$, set addresses and give "H" pulse to CS2.
- (3) Hold $\overline{\text{CS1}} = \text{"L"}$, $\text{CS2} = \text{"H"}$, set addresses and give "L" pulse to $\overline{\text{WE}}$.
- (4) After setting addresses, give "L" pulse to $\overline{\text{CS1}}$, $\overline{\text{WE}}$ and give "H" pulse to CS2.

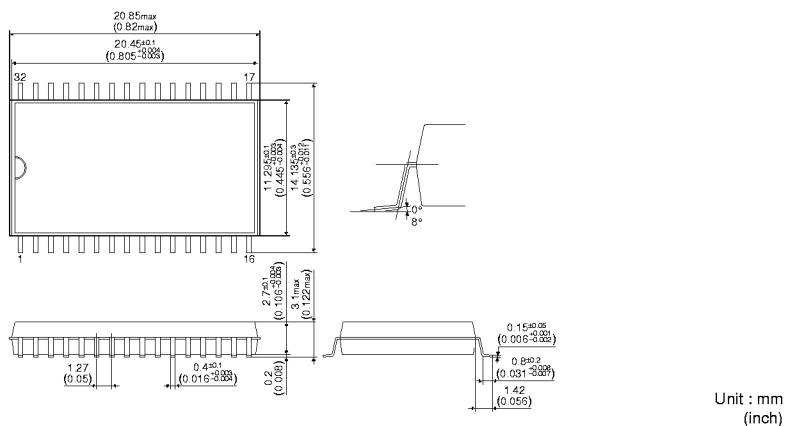
Anyway, data on the Data I/O terminals are latched up into the SRM20V100LLMT₇ at the end of the period that $\overline{\text{CS1}}, \overline{\text{WE}}$ are "L" level, and CS2 is "H" level. As Data I/O terminals are in high impedance state when any of $\overline{\text{CS1}}, \overline{\text{OE}} = \text{"H"}$, or $\text{CS2} = \text{"L"}$, the contention on the data bus can be avoided.

● Standby mode

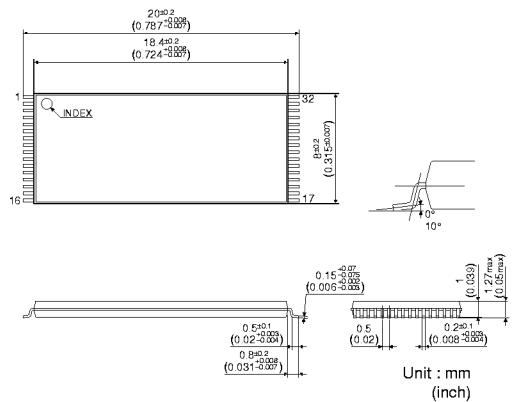
When $\overline{\text{CS1}}$ is "H" or CS2 is "L" level, the SRM20V100LLMT₇ is in the standby mode which has retaining data operation. In this case Data I/O terminals are Hi-Z, and all inputs of addresses, $\overline{\text{WE}}$ and data can be any "H" or "L". When CS1 and CS2 level are in the range over V_{DD}-0.2V, CS2 level is in the range under 0.2V, in the SRM20V100LLMT₇ there is almost no current flow except through the high resistance parts of the memory.

■ PACKAGE DIMENSIONS

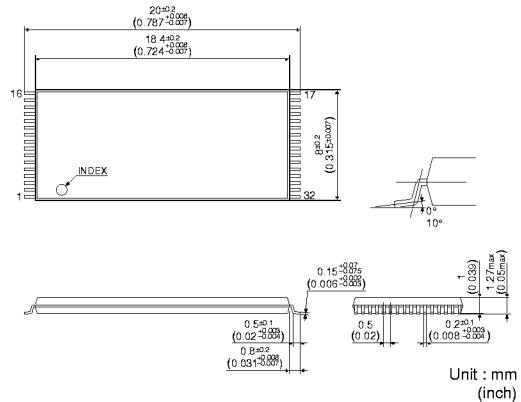
Plastic SOP6-32pin



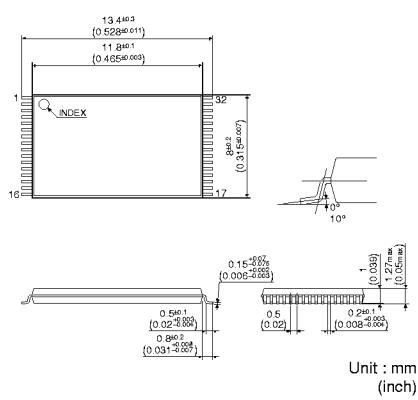
Plastic TSOP(I)-32pin



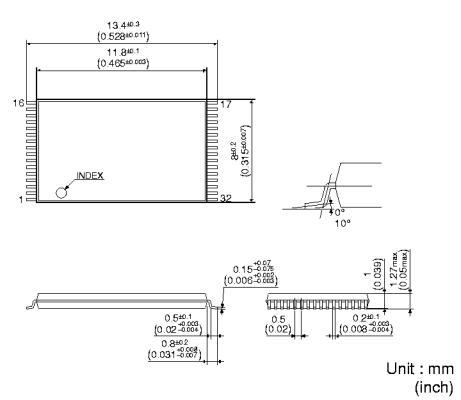
Plastic TSOP(I)-32pin-R1



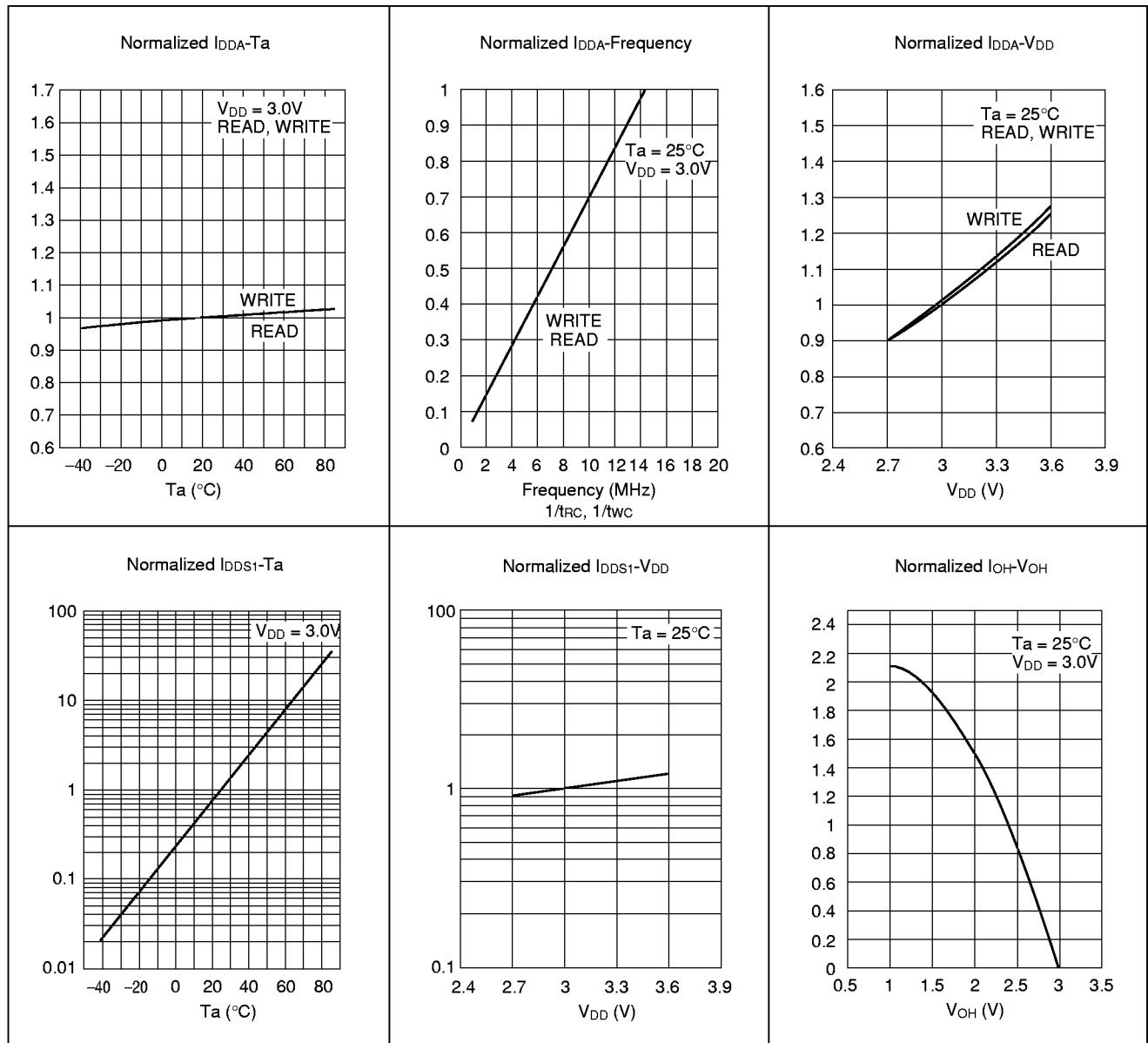
Plastic Slim-TSOP(I)-32pin

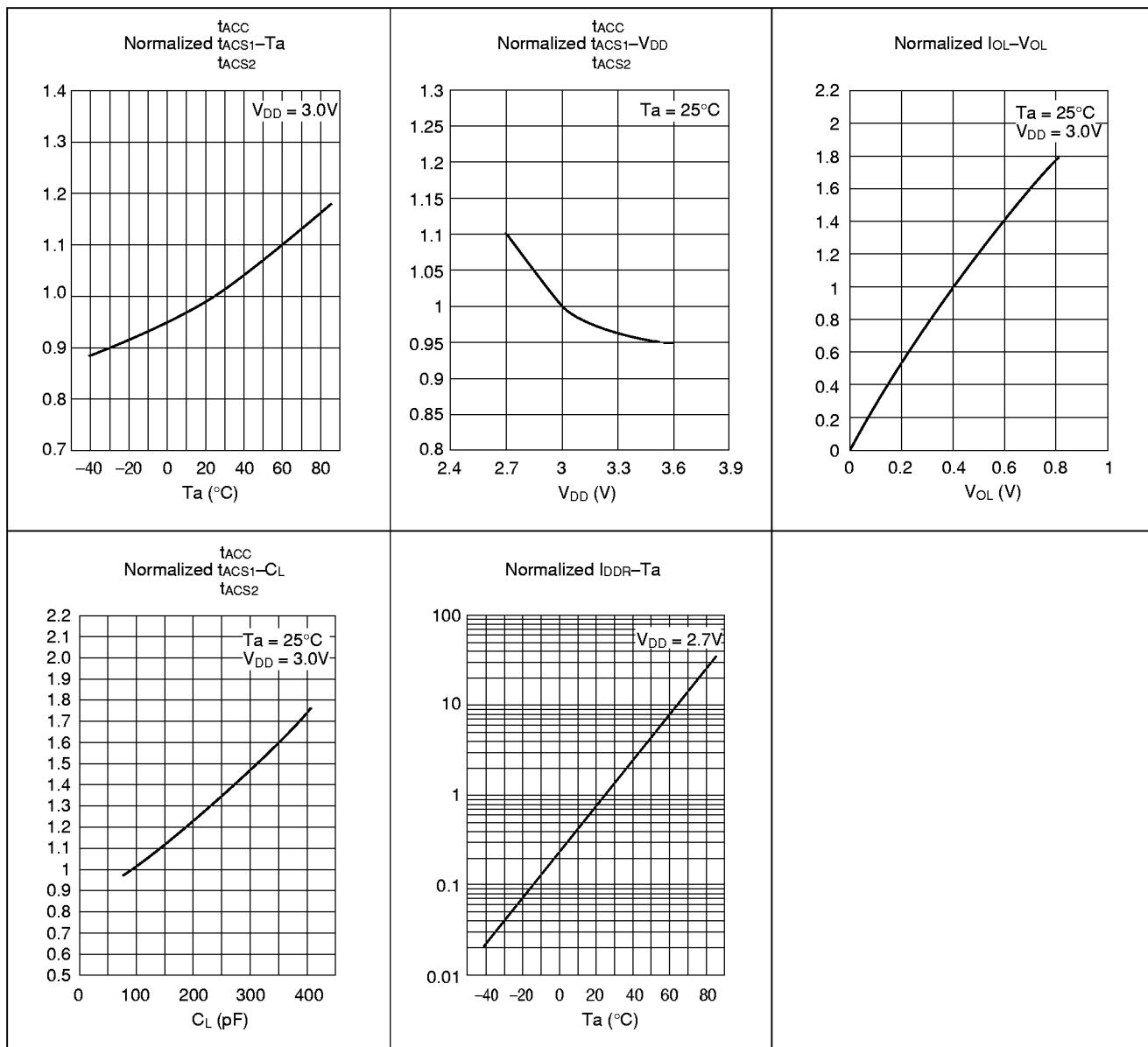


Plastic Slim-TSOP(I)-32pin-R1



■ CHARACTERISTICS CURVES





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